



Click [here](#) for the 3D model.

| Dimensions | |
|------------|------------------|
| Chip Size | 0840(3431) |
| L | 8.65mm +/-0.25mm |
| W | 8mm +/-0.2mm |
| T | 4mm MAX |
| G | 5.1mm +/-0.3mm |

| Packaging Specifications | |
|--------------------------|------------|
| Typical Component Weight | 1.45 g |
| Packaging | T&R, 330mm |
| Packaging Quantity | 1000 |

| General Information | |
|---------------------|------------------------------|
| Series | MPX |
| Style | SMD Molded |
| Core | Metal Composite |
| Description | Surface Mount Inductor |
| Features | Power Inductors |
| RoHS | Yes |
| Miscellaneous | 40 (K) Temperature Rise Max. |

| Specifications | |
|-------------------------|---|
| Inductance | 1000 nH |
| Inductance Tolerance | 20% |
| Temperature Range | -55/+155°C |
| Shielded | Yes |
| Current | 20.8 A (Irms, 40C Rise By Self Heating), 19.5 A (Isat, 20% Drop In Inductance), 28 A (Isat, 30% Drop In Inductance) |
| DC Resistance | 4.2 mOhms |
| Self-Resonant Frequency | 40 MHz |

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